

LESD9D12T5G ESD PROTECTION DIODE

Discription

The LESD9D12T5G is designed to protect voltage sensitive components from ESD. Excellent clamping capability, low leakage, and fast response time provide best in class protection on designs that are exposed to ESD. Because of its small size, it is suited for use in cellular phones, MP3 players, digital cameras and many other portable applications where board space is at a premium.

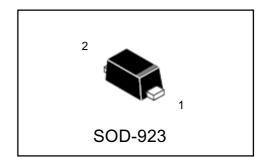
Applications

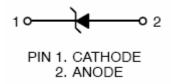
- I Cellular phones audio
- I MP3 players
- I Digital cameras
- I Portable applicationss
- I mobile telephone

Features

- Small Body Outline Dimensions:
 - 0.039" x 0.024"(1.0 mm x 0.60 mm)
- Low Body Height: 0.017" (0.43 mm) Max
- Stand-off Voltage: 3.3 V 12 V
- Low Leakage
- Response Time is Typically < 1 ns
- ESD Rating of Class 3 (> 16 kV) per Human Body Model
- IEC61000-4-2 Level 4 ESD Protection
- We declare that the material of product compliance with RoHS requirements.
- S- Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

LESD9D12T5G S-LESD9D12T5G





Ordering information

Device	Marking	Shipping		
LESD9D12T5G S-LESD9D12T5G	н	8000/Tape&Reel		

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
IEC 61000-4-2 (ESD) Air Contact Contact discharge		±15 ±8	kV kV
ESD Voltage Per Human Body Model		16	kV
Total Power Dissipation on FR-5 Board (Note 1) @ $T_A=25^{\circ}$ C	PD	150	Mw
Junction and Storage Temperature Range	TJ,TSTG	-55 to 150	$^{\circ}$
Lead Solder Temperature – Maximum (10 Second Duration)	TL	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Rating are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. FR-5 = 1.0*0.75*0.62 in.

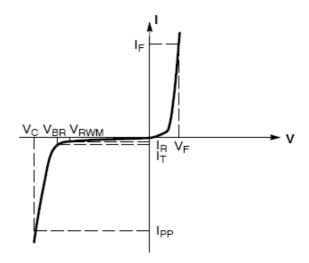


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ELECTRICAL CHARACTERISTICS

(T_A = 25°C unless otherwise noted)

Symbol	Parameter
I _{PP}	Maximum Reverse Peak Pulse Current
V _C	Clamping Voltage @ IPP
V _{RWM}	Working Peak Reverse Voltage
I _R	Maximum Reverse Leakage Current @ V _{RWM}
V _{BR}	Breakdown Voltage @ I _T
I _T	Test Current
I _F	Forward Current
V _F	Forward Voltage @ I _F
P _{pk}	Peak Power Dissipation
С	Max. Capacitance @V _R = 0 and f = 1 MHz



Uni-Directional TVS

ELECTRICAL CHARACTERISTICS (T_A=25°C unless otherwise noted, VF=0.9V Max. @ IF=10Ma for all types)

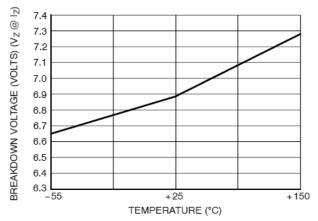
	V_{RWM}	I _R	V_{BR}	I _T	I _{PP}	Vc	P _{PK}	С
	(V)	(µ A)	(V)	(mA)	(A)	(V)	(W)	(pF)
Device		@	@ I _T			@ Max I _{PP}	(8*20 µs)	
		V_{RWM}	(Note 2)		(Note 3)	(Note 3)		
	Max	Max	Min		Max	Max	Тур	Тур
LESD9D3.3T5G	3.3	2.5	5.0	1.0	9.8	10.4	102	80
LES D9D5.0T5G	5.0	1.0	6.2	1.0	8.7	12.3	107	65
LESD9D12T5G	12	1.0	13.5	1.0	5.9	23.7	140	30

Other voltage available upon request.

- 3. Surge current waveform per Figure 3.



LESD9D12T5G, S-LESD9D12T5G TYPICAL CHARACTERISTICS



18 16 14 12 10 8 6 +150 +25 TEMPERATURE (°C)

Figure 1. Typical Breakdown Voltage versus Temperature

Fig 2. Typical Leakage Current versus **Temperature**

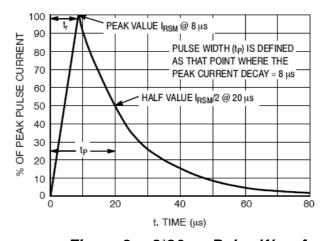
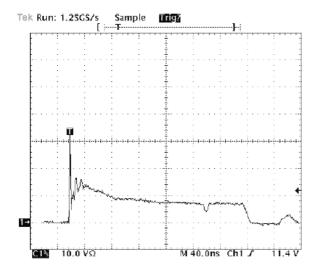
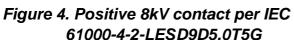


Figure 3. 8*20 µs Pulse Waveform





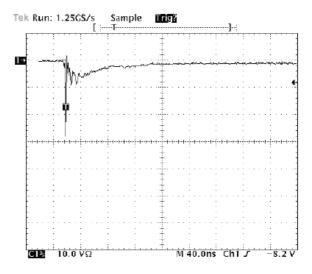
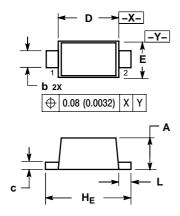


Fig 5. Negative 8kV contact per IEC 61000-4-2-LESD9D5.0T5G



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SOD-923



- NOTES:

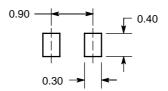
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: MILLIMETERS.

 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.34	0.37	0.40	0.013	0.015	0.016
b	0.15	0.20	0.25	0.006	0.008	0.010
С	0.07	0.12	0.17	0.003	0.005	0.007
D	0.75	0.80	0.85	0.030	0.031	0.033
Е	0.55	0.60	0.65	0.022	0.024	0.026
HE	0.95	1.00	1.05	0.037	0.039	0.041
L	0.05	0.10	0.15	0.002	0.004	0.006

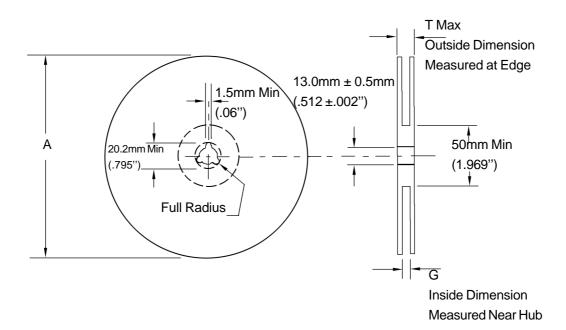
SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS



EMBOSSED TAPE AND REEL DATA FOR DISCRETES CARRIER TAPE SPECIFICATIONS



Size	A Max	G	T Max
8 mm	178.0mm	8.4mm+1.5mm, -0.0	10.9mm
	(7.0")	(.33"+.039", -0.00)	(.43")

Reel Dimensions

Metric Dimensions Govern — English are in parentheses for reference only

Storage Conditions

Temperature: 5 to 40 Deg.C (20 to 30 Deg. C is preferred) Humidity: 30 to 80 RH (40 to 60 is preferred) Recommended Period: One year after manufacturing

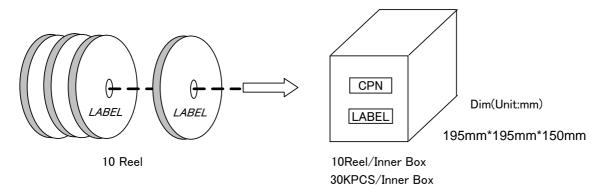
(This recommended period is for the soldering condition only. The characteristics and reliabilities of the products are not restricted to

this limitation)

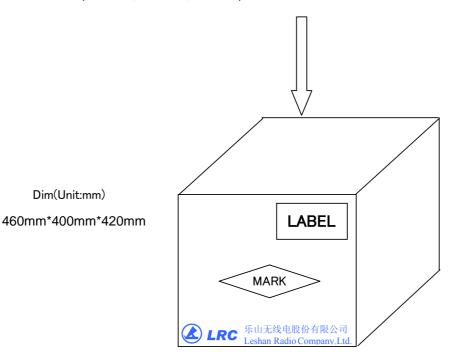
Tape peeling strength: 10 to 100 (g).



Shipment Specification



3000PCS/Reel 80KPCS/Inner Box (SOT-723,SOD-723,SOD-923) 8000PCS/Reel (SOT-723,SOD-723,SOD-923)



12 Inner Box/Carton

360KPCS/Carton 960KPCS/Carton (SOT-723,SOD-723,SOD-923)